

STW54NM65ND

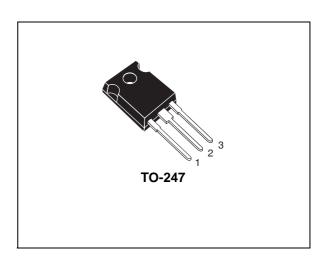
N-channel 650 V, 0.055 Ω typ., 49 A FDmesh™ II Power MOSFET (with fast diode) in a TO-247 package

Datasheet — production data

Features

Order code	V _{DSS} (@Tjmax)	R _{DS(on)} max.	I _D
STW54NM65ND	710 V	< 0.065 Ω	49 A

- The worldwide best R_{DS(on)} * area amongst the fast recovery diode devices
- 100% avalanche tested
- Low input capacitance and gate charge
- Low gate input resistance
- Extremely high dv/dt and avalanche capabilities



Application

Switching applications

Description

The device is an N-channel FDmesh™ II Power MOSFET that belongs to the second generation of MDmesh™ technology. This revolutionary Power MOSFET associates a new vertical structure to the company's strip layout and associates all advantages of reduced onresistance and fast switching with an intrinsic fast-recovery body diode. It is therefore strongly recommended for bridge topologies, in particular ZVS phase-shift converters.

Figure 1. Internal schematic diagram

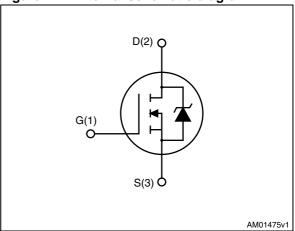


Table 1. Device summary

Order code	Marking	Package	Packaging	
STW54NM65ND	54NM65ND	TO-247	Tube	

Contents STW54NM65ND

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STW54NM65ND Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	650	V
V _{GS}	Gate- source voltage	± 25	V
I _D	Drain current (continuous) at T _C = 25 °C	49	Α
I _D	Drain current (continuous) at T _C = 100 °C	31	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	196	Α
P _{TOT}	Total dissipation at T _C = 25 °C	350	W
dv/dt (2)	Peak diode recovery voltage slope	40	V/ns
T _{stg}	Storage temperature	- 55 to 150	°C
T _j	Max. operating junction temperature	150	°C

^{1.} Pulse width limited by safe operating area

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	0.36	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max	50	°C/W
T _I	Maximum lead temperature for soldering purpose	300	°C

Table 4. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AS}	Avalanche current, repetitive or not-repetitive (pulse width limited by $T_{\rm j}$ max)	15	Α
E _{AS}	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AS}$, $V_{DD} = 50$ V)	850	mJ

^{2.} $I_{SD} \leq$ 49 A, di/dt \leq 600 A/ μ s, V_{DD} = 80% $V_{(BR)DSS}$

Electrical characteristics STW54NM65ND

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 5. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1 mA, V _{GS} = 0	650			V
dv/dt ⁽¹⁾	Drain source voltage slope	$V_{DD} = 480 \text{ V}, I_{D} = 49 \text{ A}, V_{GS} = 10 \text{ V}$		30		V/ns
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = 650 V V _{DS} = 650 V, T _C = 125 °C			10 100	μA μA
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 20 V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 24.5 A		0.055	0.065	Ω

^{1.} Characteristic value at turn off on inductive load.

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} = 50 V, f = 1 MHz, V _{GS} = 0	-	6200 218 10	-	pF pF pF
Coss eq. (1)	Output equivalent capacitance	V _{DS} =0 to 200 V V _{GS} =0	-	850	-	рF
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 520 \text{ V}, I_{D} = 49 \text{ A},$ $V_{GS} = 10 \text{ V},$ (see Figure 14)	-	188 32 100	-	nC nC nC
t _C t _r t _{d(off)} t _f	Crossing time Rise time Turn-off delay time Fall time	$V_{DD} = 520 \text{ V}, I_{D} = 49 \text{ A},$ $R_{G} = 4.7 \Omega, V_{GS} = 10 \text{ V}$ (see Figure 17), (see Figure 13)	-	33 59 152 98	-	ns ns ns ns
R _g	Gate input resistance	f=1 MHz gate DC bias=0 Test signal level = 20 mV open drain	-	1.9	-	Ω

C_{oss eq.} is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DS}.

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current Source-drain current (pulsed)		-		49 196	A A
V _{SD} (2)	Forward on voltage	I _{SD} = 49 A, V _{GS} = 0	-		1.3	V
t _{rr}	Reverse recovery time	$I_{SD} = 49 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$		212		ns
Q_{rr}	Reverse recovery charge	V _{DD} = 60 V	-	2		μC
I _{RRM}	Reverse recovery current	Figure 15		19		Α
t _{rr}	Reverse recovery time	$I_{SD} = 49 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$		296		ns
Q_{rr}	Reverse recovery charge	V _{DD} = 60 V, T _j = 150 °C	-	4		μC
I _{RRM}	Reverse recovery current	Figure 15		28		Α

^{1.} Pulse width limited by safe operating area

^{2.} Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

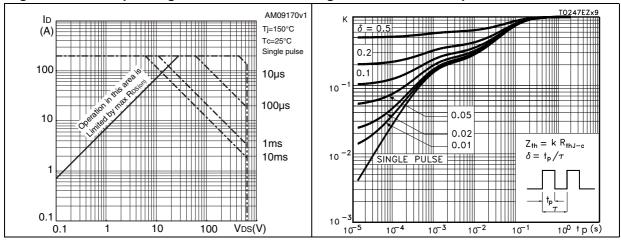


Figure 4. Output characteristics

Figure 5. Transfer characteristics

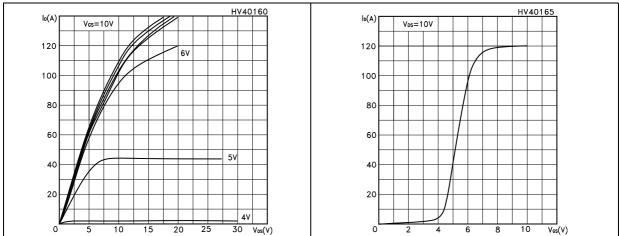
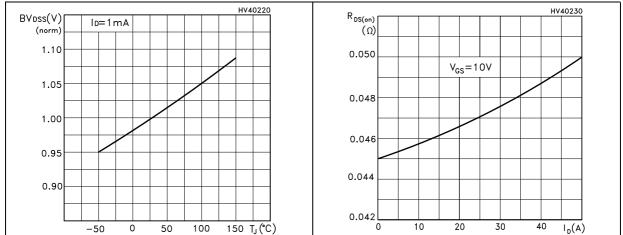


Figure 6. Normalized B_{VDSS} vs temperature Figure 7. Static drain-source on-resistance



AM09171v1 AM09172v1 C (pF) Vgs (V) VDD=520V 12 500 ID=49A 10000 Ciss VDS 10 400 1000 8 300 Coss 100 200 10 Crss 100 Qg(nC) 50 100 150 200 100 V_{DS}(V) 0.1 10

Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature temperature

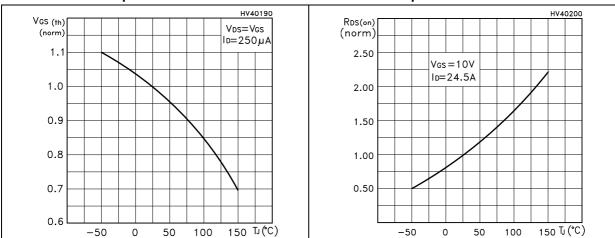
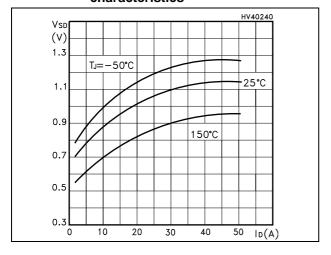


Figure 12. Source-drain diode forward characteristics



Test circuits STW54NM65ND

3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

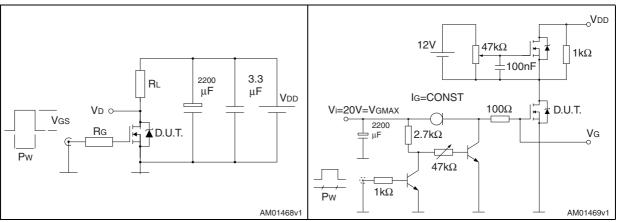


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped inductive load test circuit

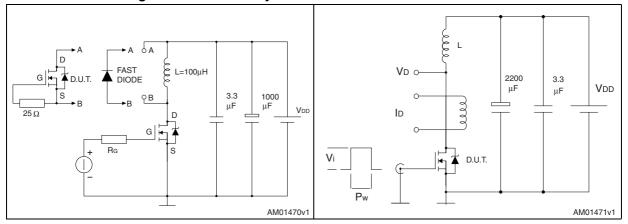
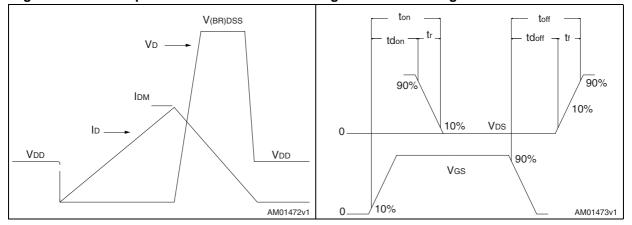


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



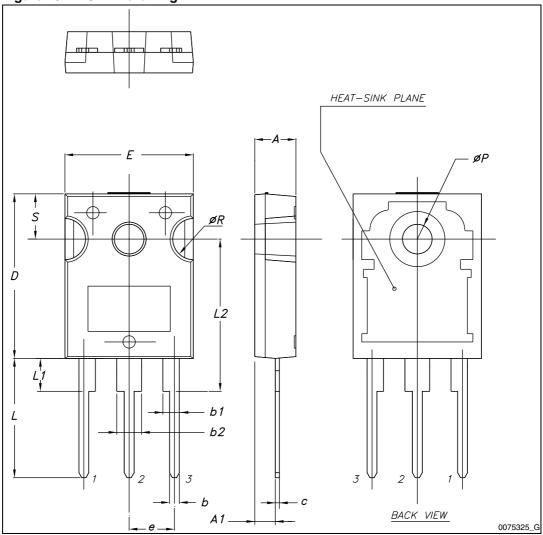
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Table 8. TO-247 mechanical data

Dim		mm.	
Dim.	Min.	Тур.	Max.
Α	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
E	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

Figure 19. TO-247 drawing



Revision history STW54NM65ND

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
03-Jun-2011	1	Initial release
19-Dec-2012	2	Updated title on the cover page. Inserted dv/dt parameter in <i>Table 5</i> . Updated <i>Section 4: Package mechanical data</i> .

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